

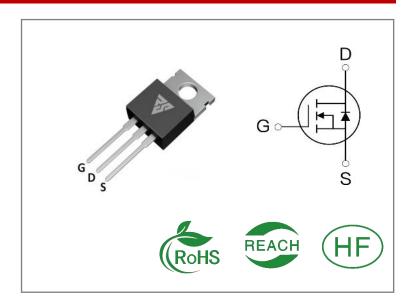
ID	R _{DS} (ON)(Typ)	VDSS
150A	2.8mΩ	85V

Applications:

- Load Switch
- PWM Applications
- Power Managment

Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability



Ordering Information

Part Number	Package	Marking	Packing	Qty.
RS85N150T	T0-220	RS85N150T	Tube	50 PCS

Absolute Maximun Ratings Tc= 25℃ unless otherwise specified

Symbol	Parameter	RS85N150T	Units
VDSS	Drain-to-Source Voltage	85	V
ID	Continuous Drain Current TC=25℃	150	
ID	Continuous Drain Current TC=100°C	140	Α
IDM	Pulsed Drain Current	600	
PD	Power Dissipation	310	W
VGS	Gate- to- Source Voltage	±20	V
EAS	Single Pulse Avalanche Engergy L = 0.5mH,IS = 55A, RG = 25Ω , Tj = 25° C	750	mJ
	Maximum Temperature for Soldering		
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	300 260	$^{\circ}$
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150	

^{*} Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" Table may cause permanent damage to the device.



Thermal Resistance

Symbol	Parameter	RS85N150T	Units	Test Conditions
RθJC	Junction-to-Case	0.4	°C/W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^{\circ}\mathrm{C}$
RθJA	Junction-to- Ambient	52		1 cubic foot chamber,free air.

OFF Characteristics TJ= 25℃ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	85			V	VGS=0V,ID=250μ A
IDSS	Drain- to- Source Leakage Current			1	μΑ	VDS=80V,VGS=0 V
IGSS	Gate- to- Source Forward Leakage			100	nA	VGS=20V ,VDS=0 V
1033	Gate- to- Source Reverse Leakage			-100		VGS=-20V ,VDS= 0V

ON Characteristics TJ=25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On- Resistance		2.8	3.6	mΩ	VGS=10V,ID=60A
VGS(TH	Gate Threshold Voltage	2.0		4.0	V	VGS=VDS,ID=25 0μA

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		37			VDS=43V ID=60A
trise	Rise Time		63			
td(OFF)	Turn- OFF Delay Time		78		nS	RG=4.7Ω
tfall	Fall Time		41			VGS=10V



Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
Ciss	Input Capacitance		7447			VGS= 0V	
Coss	Output Capacitance		1075		рF	VDS=43V	
Crss	Reverse Transfer Capacitance		43			f=100KHz	
Qg	Total Gate Charge		130			VDS= 68V	
Qgs	Gate- to- Source Charge		40		nC	ID=60A	
Qgd	Gate-to-Drain(" Miller") Charge		39			VGS=10V	

Source-Drain Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current			150	Α	Integral pn- diode
ISM	Maximum Pulsed Current			600	Α	in MOSFET
VSD	Diode Forward Voltage			1.4	V	IS=60A,VGS=0V
trr	Reverse Recovery Time		56		nS	VGS=0V
Qrr	Reverse Recovery Charge		84		nC	IS=60A di/dt=100A/μs

Notes:

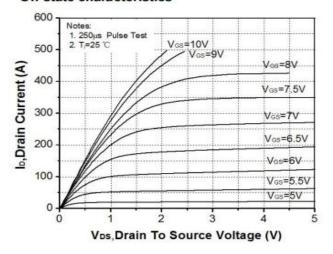
^{* 1.} Repetitive rating, pulse width limited by maximum junction temperature.

^{* 2.} Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 1.5%

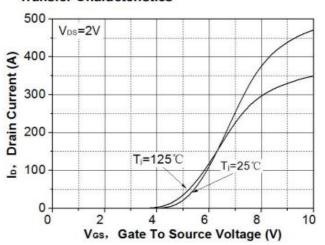


Typical Feature Curve

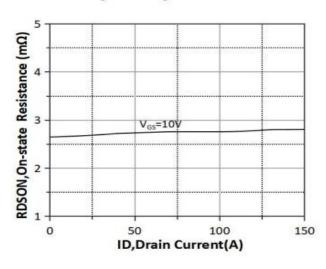
On-state characteristics



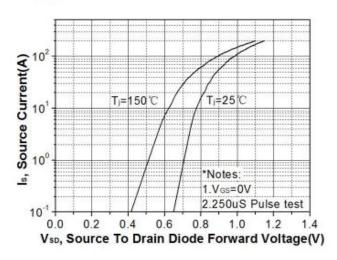
Transfer Characteristics



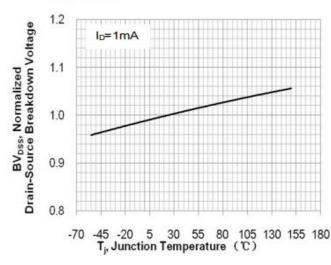
On-resistance variation vs.drain current and gate voltage



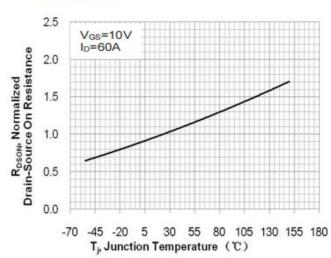
On-state current vs. diode forward voltage



Breakdown voltage variation vs. junction temperature

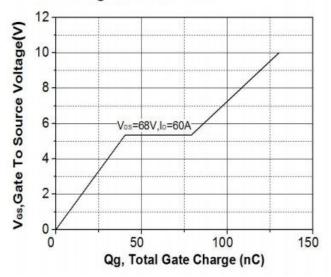


On-resistance variation vs. junction temperature

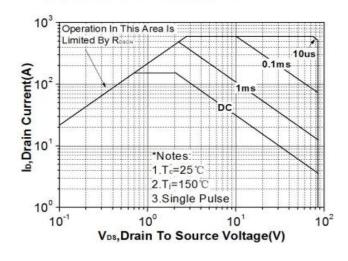




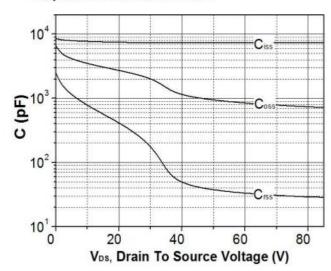
Gate charge characteristics



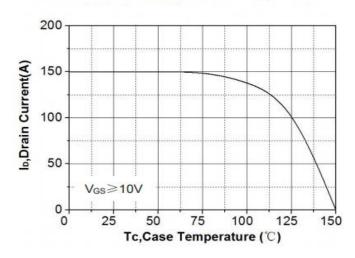
Maximum safe operating area



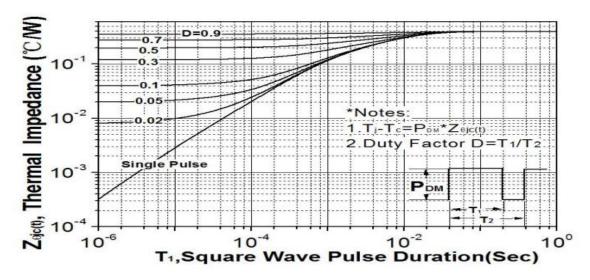
Capacitance characteristics



Maximum drain current vs. case temperature



Transient thermal response curve





Test ircuits and Waveforms

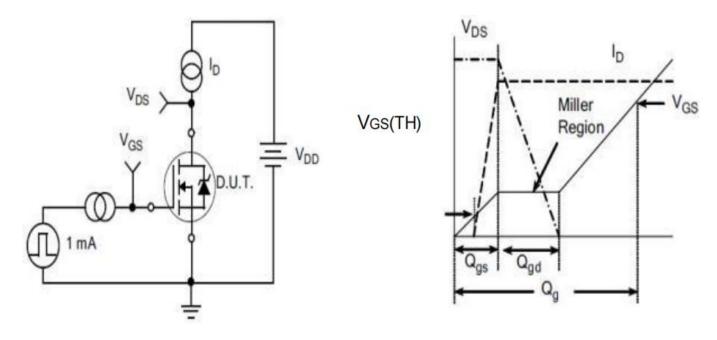


Figure A.
Gate Charge Test Circuit

V_{DS} V_{DS} V_{DS} D.U.T. V_{DS} 10%

VGS -

td(ON) trise

Figure C.
Resistive Switching Test Circuit

Figure D.
Resistive Switching Waveforms

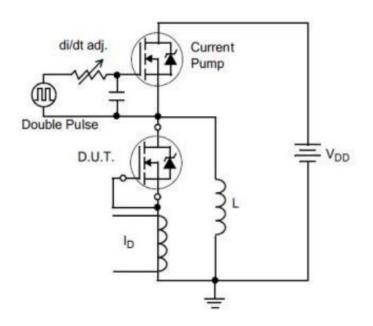
t_{d(OFF)} t_{fall}

Figure B.

Gate Charge Waveform



Test ircuits and Waveforms



 $\frac{di/dt = 100A/\mu A}{Q_{rr}}$

Figure E.Diode Reverse Recovery Test Circuit

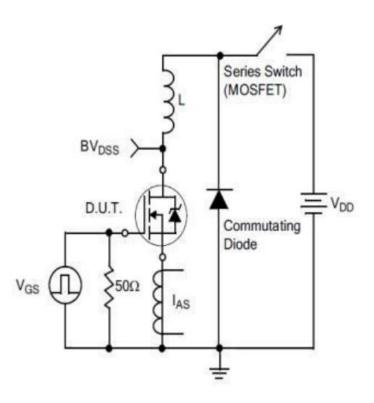


Figure F.Diode Reverse Recovery Waveform

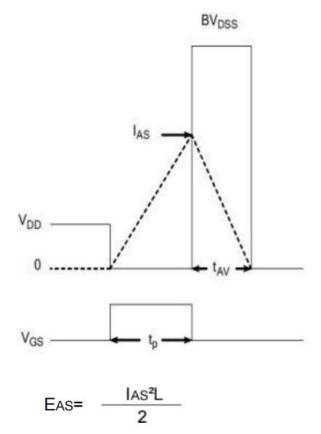


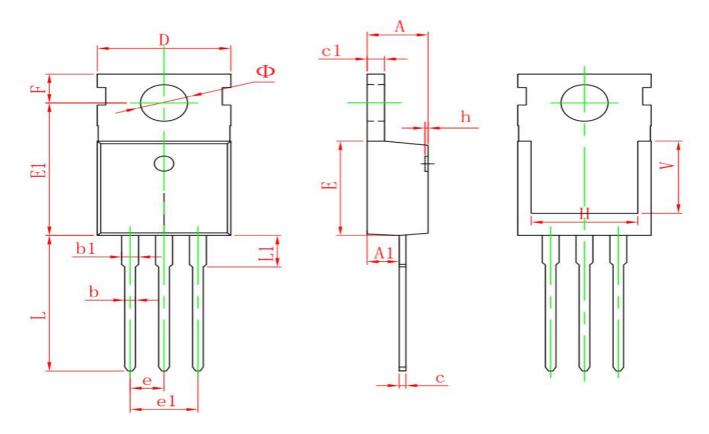
Figure G.Unclamped Inductive Switching Test Circuit

Figure H.Unclamped Inductive Switching Waveforms

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Package outline drawing(TO-220 Unit: mm)



Symbol	Dimensions	In Millimeters	Dimension	s In Inches	
Syllibol	Min.	Max.	Min.	Max.	
Α	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
Е	8.950	9.750	0.352	0.384	
E1	12.650	13.050	0.498	0.514	
е	2.540	TYP.	0.100	TYP.	
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	6.900	REF.	0.276 REF.		
Φ	3.400	3.800	0.134	0.150	



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